

CMOS Digital Integrated Circuits Silicon Monolithic

7UL1G17FU

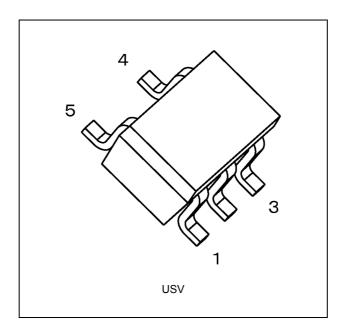
1. Functional Description

· Schmitt Buffer

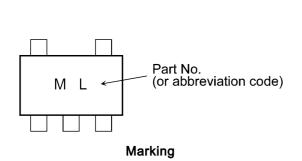
2. Features

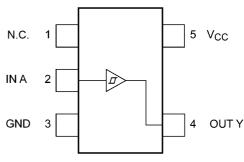
- (1) Wide operating temperature range: $T_{opr} = -40$ to 125 °C
- (2) High output current: ± 8.0 mA (min) at $V_{CC} = 3.0$ V
- (3) Super high speed operation: $t_{pd} = 3.0$ ns (typ.) at $V_{CC} = 3.3$ V, $C_L = 15$ pF
- (4) Operating voltage range: $V_{CC} = 0.9$ to 3.6 V
- (5) 3.6 V tolerant input
- (6) 3.6 V power down protection output

3. Packaging



4. Marking and Pin Assignment





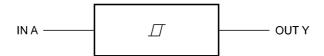
Pin Assignment (Top view)

Start of commercial production

2021-04



5. IEC Logic Symbol



6. Truth Table

Input A	Output Y
L	L
Н	Н

7. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 4.6	V
Input voltage	V_{IN}		-0.5 to 4.6	V
DC output voltage	V_{OUT}	(Note 1)	-0.5 to 4.6	V
		(Note 2)	-0.5 to V _{CC} + 0.5	
Input diode current	I _{IK}		-20	mA
Output diode current	I _{OK}	(Note 3)	-20	mA
DC output current	l _{out}		±25	mA
V _{CC} /ground current	I _{CC}		±50	mA
Power dissipation	P_D		200	mW
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: $V_{CC} = 0 V$

Note 2: High (H) or Low (L) state. I_{OUT} absolute maximum rating must be observed.

Note 3: V_{OUT} < GND



8. Operating Ranges (Note)

Characteristics	Symbol	Note	Test Condition Rating		Unit
Supply voltage	V _{CC}		_	0.9 to 3.6	V
Input voltage	V _{IN}		_	0 to 3.6	V
Output voltage	V _{OUT}	(Note 1)	_	0 to 3.6	V
		(Note 2)	_	0 to V _{CC}	
Output current	I _{OH} ,I _{OL}		V _{CC} = 3.0 to 3.6 V	±8.0	mA
			V _{CC} = 2.3 to 2.7 V	±4.0	
			V _{CC} = 1.65 to 1.95 V	±3.0	
			V _{CC} = 1.4 to 1.6 V ±1.7		
			V _{CC} = 1.1 to 1.3 V	±0.3	
			V _{CC} = 0.9 V	±0.02	
Operating temperature	T _{opr}		_	-40 to 125	°C

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either V_{CC} or GND.

Note 1: $V_{CC} = 0 V$

Note 2: High (H) or Low (L) state.



9. Electrical Characteristics

9.1. DC Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	ı	V _{CC} (V)	Min	Тур.	Max	Unit
Positive threshold voltage	V_P	_		0.9	_	_	0.73	V
					_	_	0.86	
				1.4	_	_	1.07	
				1.65	_	_	1.23	
				2.3	_	_	1.66	
				3.0	_	_	2.14	
Negative threshold	V _N	_		0.9	0.18	_	_	V
voltage				1.1	0.26	_	_	
				1.4	0.36	_	_	
				1.65	0.45	_	_	
				2.3	0.69	_	_	
				3.0	0.96	_	_	
Hysteresis voltage	V _H	_		0.9	0.15	_	0.38	V
				1.1	0.18	_	0.41	
				1.4	0.20	_	0.48	
				1.65	0.22	_	0.60	
				2.3	0.35	-	0.76	
				3.0	0.45	_	0.93	
High-level output voltage	V _{OH}	$V_{IN} = V_{IH}$	I _{OH} = -0.02 mA	0.9	0.75	ı	_	V
			I_{OH} = -0.3 mA	1.1 to 1.3	$V_{CC} \times 0.75$		_	
			I _{OH} = -1.7 mA	1.4 to 1.6	V _{CC} × 0.75	_	_	
			I_{OH} = -3.0 mA	1.65 to 1.95	V _{CC} -0.45	ı	_	
			I_{OH} = -4.0 mA	2.3 to 2.7	2.0		_	
			I_{OH} = -8.0 mA	3.0 to 3.6	2.48	_	_	
Low-level output voltage	V _{OL}	$V_{IN} = V_{IL}$	I _{OL} = 0.02 mA	0.9	_	ı	0.1	V
			I_{OL} = 0.3 mA	1.1 to 1.3	_		$V_{CC}\times 0.25$	
			I _{OL} = 1.7 mA	1.4 to 1.6	_	_	$V_{CC} \times 0.25$	
			I _{OL} = 3.0 mA	1.65 to 1.95	_	_	0.45	
			I _{OL} = 4.0 mA	2.3 to 2.7	_		0.4	
			I _{OL} = 8.0 mA	3.0 to 3.6	_	_	0.4	
Input leakage current	I _{IN}	V _{IN} = 0 to 3.6 V		0 to 3.6	_		±0.1	μА
Power-OFF leakage current	I _{OFF}	V _{IN} = 0 to 3.6 V, V _{OUT} = 0 to 3.6 V		0	_		1.0	μА
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND		3.6	_	_	1.0	μА



9.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Test Condition	on	V _{CC} (V)	Min	Max	Unit
Positive threshold voltage	V _P	_		0.9	_	0.73	V
				1.1	_	0.86	
				1.4	_	1.07	
				1.65	_	1.23	
				2.3	_	1.66	
				3.0	_	2.14	
Negative threshold voltage	V _N	_		0.9	0.18	_	V
				1.1	0.26	_	
				1.4	0.36	_	
				1.65	0.45	_	
				2.3	0.69	_	
				3.0	0.96	_	
Hysteresis voltage	V _H	_		0.9	0.15	0.38	V
				1.1	0.18	0.41	
				1.4	0.20	0.48	
				1.65	0.22	0.60	
				2.3	0.35	0.76	
				3.0	0.45	0.93	
High-level output voltage	V _{OH}	V _{IN} = V _{IH}	I _{OH} = -0.02 mA	0.9	0.75	_	V
			$I_{OH} = -0.3 \text{ mA}$	1.1 to 1.3	V _{CC} × 0.75	_	
			I _{OH} = -1.7 mA	1.4 to 1.6	V _{CC} × 0.75	_	
			I _{OH} = -3.0 mA	1.65 to 1.95	V _{CC} -0.45	_	
			I _{OH} = -4.0 mA	2.3 to 2.7	2.0	_	
			I _{OH} = -8.0 mA	3.0 to 3.6	2.48	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IL}	I _{OL} = 0.02 mA	0.9	_	0.1	V
			$I_{OL} = 0.3 \text{ mA}$	1.1 to 1.3	_	$V_{CC} \times 0.25$	
			I _{OL} = 1.7 mA	1.4 to 1.6	_	V _{CC} × 0.25	
			I _{OL} = 3.0 mA	1.65 to 1.95	_	0.45	
			I _{OL} = 4.0 mA	2.3 to 2.7	_	0.4	
			I _{OL} = 8.0 mA	3.0 to 3.6	_	0.4	
Input leakage current	I _{IN}	V _{IN} = 0 to 3.6 V		0 to 3.6	_	±0.5	μА
Power-OFF leakage current	I _{OFF}	V _{IN} = 0 to 3.6 V, V _{OUT} = 0 to 3.6 V		0	_	10.0	μА
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND		3.6		10.0	μΑ



9.3. DC Characteristics (Unless otherwise specified, T_a = -40 to 125 °C)

Characteristics	Symbol	Test Condition	on	V _{CC} (V)	Min	Max	Unit
Positive threshold voltage	V _P	_		0.9	_	0.73	V
				1.1	_	0.86	
				1.4	_	1.07	
				1.65	_	1.23	
				2.3	_	1.66	
				3.0	_	2.14	V
Negative threshold voltage	V _N	_		0.9	0.18	_	
				1.1	0.26	_	
				1.4	0.36	_	
				1.65	0.45	_	
				2.3	0.69	_	
				3.0	0.96	_	
Hysteresis voltage	V _H	_		0.9	0.15	0.38	V
				1.1	0.18	0.41	
				1.4	0.20	0.48	
				1.65	0.22	0.60	
				2.3	0.35	0.76	
				3.0	0.45	0.93	
High-level output voltage	V _{OH}	V _{IN} = V _{IH}	I _{OH} = -0.02 mA	0.9	0.75	_	V
			$I_{OH} = -0.3 \text{ mA}$	1.1 to 1.3	V _{CC} × 0.73	_	
			I _{OH} = -1.7 mA	1.4 to 1.6	V _{CC} × 0.73	_	
			I _{OH} = -3.0 mA	1.65 to 1.95	V _{CC} -0.5	_	
			I _{OH} = -4.0 mA	2.3 to 2.7	1.95	_	
			I _{OH} = -8.0 mA	3.0 to 3.6	2.4	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IL}	I _{OL} = 0.02 mA	0.9	_	0.1	V
			$I_{OL} = 0.3 \text{ mA}$	1.1 to 1.3	_	V _{CC} × 0.27	
			I _{OL} = 1.7 mA	1.4 to 1.6	_	V _{CC} × 0.27	
			I _{OL} = 3.0 mA	1.65 to 1.95	_	0.5	
			I _{OL} = 4.0 mA	2.3 to 2.7	_	0.45	
			I _{OL} = 8.0 mA	3.0 to 3.6	_	0.45	
Input leakage current	I _{IN}	V _{IN} = 0 to 3.6 V		0 to 3.6	_	±2.0	μΑ
Power-OFF leakage current	I _{OFF}	V _{IN} = 0 to 3.6 V, V _{OUT} = 0 to 3.6 V		0	_	80.0	μА
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		3.6	_	80.0	μΑ



9.4. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Unit				
Propagation delay time	t _{PLH} ,t _{PHL}		$R_L = 1 M\Omega$	0.9	10	_	22.0	_	ns				
			See Fig. 9.7.1, Table 9.7.1	1.1 to 1.3		_	11.1	22.6					
			Table 9.7.1	1.4 to 1.6			6.7	10.5					
				1.65 to 1.95		_	5.0	7.8					
				2.3 to 2.7			3.3	5.4					
				3.0 to 3.6			2.7	4.4					
Propagation delay time	t _{PLH} ,t _{PHL}		$R_L = 1 M\Omega$	0.9	15		24.2		ns				
			See Fig. 9.7.1, Table 9.7.1	1.1 to 1.3		_	12.1	25.1					
							Table 9.7.1	1.4 to 1.6			7.3	11.5	.
				1.65 to 1.95		_	5.5	8.4					
				2.3 to 2.7		_	3.7	5.7					
				3.0 to 3.6		_	3.0	4.6					
Propagation delay time	t _{PLH} ,t _{PHL}		$R_L = 1 M\Omega$	0.9	30	_	31.0		ns				
			See Fig. 9.7.1, Table 9.7.1	1.1 to 1.3			15.7	35.7					
			Table 9.7.1	1.4 to 1.6		_	9.1	15.8					
				1.65 to 1.95		_	7.1	10.7					
				2.3 to 2.7		_	4.7	6.9					
				3.0 to 3.6		_	3.9	5.2					
Input capacitance	C _{IN}			3.6	_	_	3		pF				
Power dissipation capacitance	C _{PD}	(Note 1)	_	0.9 to 3.6	_	_	9	_	pF				

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation. $I_{CC(opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$

9.5. AC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	C _L (pF)	Min	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}	$R_L = 1 M\Omega$	0.9	10	_	_	ns
		See Fig. 9.7.1, Table 9.7.1	1.1 to 1.3		1.0	35.9	
		Table 9.7.1	1.4 to 1.6		1.0	11.3	
			1.65 to 1.95		1.0	8.2	
			2.3 to 2.7]	1.0	5.8	
			3.0 to 3.6		1.0	4.6	
Propagation delay time	t _{PLH} ,t _{PHL}	$R_L = 1 M\Omega$	0.9	15	_	_	ns
		See Fig. 9.7.1, Table 9.7.1	1.1 to 1.3]	1.0	41.8	
		14016 9.7.1	1.4 to 1.6		1.0	12.6	
			1.65 to 1.95		1.0	8.7	
			2.3 to 2.7		1.0	6.1	
			3.0 to 3.6		1.0	5.0	
Propagation delay time	t _{PLH} ,t _{PHL}	$R_L = 1 M\Omega$	0.9	30	_	_	ns
		See Fig. 9.7.1, Table 9.7.1	1.1 to 1.3	1 1	1.0	58.1	
		1.4 to 1.6		1.0	17.6		
			1.65 to 1.95]	1.0	11.7	
			2.3 to 2.7]	1.0	8.1	
			3.0 to 3.6		1.0	6.1	



9.6. AC Characteristics (Unless otherwise specified, $T_a = -40$ to 125 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	C _L (pF)	Min	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}	$R_L = 1 M\Omega$	0.9	10	_	_	ns
		See Fig. 9.7.1, Table 9.7.1	1.1 to 1.3		1.0	44.8	
		14016 9.7.1	1.4 to 1.6		1.0	11.9	
			1.65 to 1.95		1.0	8.5	
			2.3 to 2.7		1.0	6.1	
			3.0 to 3.6		1.0	4.8	
Propagation delay time	t _{PLH} ,t _{PHL}	$R_L = 1 M\Omega$	0.9	15	_	_	ns
		See Fig. 9.7.1, Table 9.7.1	1.1 to 1.3		1.0	53.0	
		Table 9.7.1	1.4 to 1.6		1.0	13.4	
			1.65 to 1.95		1.0	8.9	
			2.3 to 2.7		1.0	6.4	
			3.0 to 3.6		1.0	5.3	
Propagation delay time	t _{PLH} ,t _{PHL}	$R_L = 1 M\Omega$	0.9	30	_	_	ns
		See Fig. 9.7.1, Table 9.7.1	1.1 to 1.3		1.0	73.1	
		Table 9.7.1	1.4 to 1.6		1.0	18.8	
			1.65 to 1.95		1.0	12.4	
			2.3 to 2.7		1.0	8.9	
			3.0 to 3.6		1.0	6.7	

9.7. AC Waveform

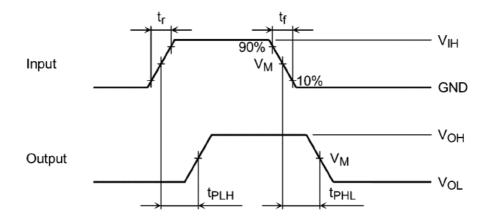


Fig. 9.7.1 t_{PLH}, t_{PHL}

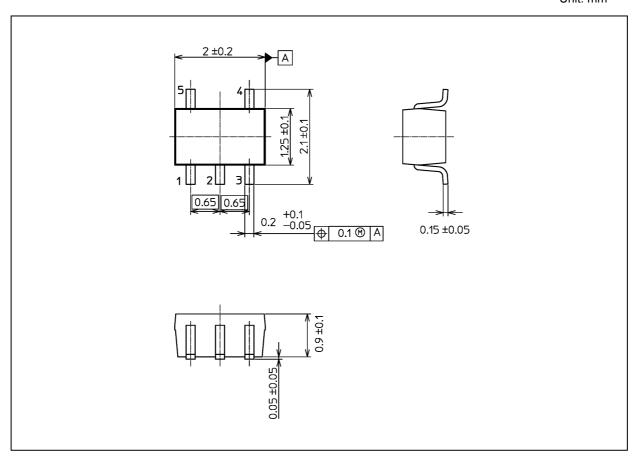
Table 9.7.1 AC Waveform Symbols

	Symbol	V _{CC} = 3.3 ± 0.3 V	V _{CC} = 2.5 ± 0.2 V	V _{CC} = 1.8 ± 0.15 V	V _{CC} = 1.5 ± 0.1 V	V _{CC} = 1.2 ± 0.1 V	V _{CC} = 0.9 V
Input	V_{IH}	V _{CC}	V _{CC}	V_{CC}	V _{CC}	V _{CC}	V _{CC}
	V_{M}	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{CC} /2
Output	V_{M}	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{CC} /2



Package Dimensions

Unit: mm



Weight: 6.2 mg (typ.)

	Package Name(s)
Nickname: USV	



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